PATENT NUMBER and ISSUE DATE



APPL NUM 10033768	FILING DATE 12/26/2001		SUBCLASS 345.82		ZZENKON			
**APPLICANT	S: Tangua	y Michae	;					
**CONTINUING DATA VERIFIED: THIS APPLICATION IS A CIP OF 09/563,784 04/29/2000 Now Pat. 6,508\$83								
** FOREIGN A	PPLICATIONS VE	RIFIED:						
PG-PUB DO N	ют РИВЦІЗН 🗖			ND 🗆				
Foreign priority cla 35 USC 119 condi Verified and Ackno		ر مورت	s Mono		ATTORNEY DOCKET NO 534-CIP			
TITLE : System	and method of pro	ocessing	composite sub	ostrates	S within a high throughput reactor U.S.DEPT. OF COMM./PAT.& TM-PTO-436L(Rev	12-94)		

NOTICE OF ALLOWANCE MAILED			CLAIMS ALLOWED					
		Assistant Examiner	Total Claims		Print Claim for O.G			
ISSUE FEE			DRAWING					
Amount Due	Date Paid	1	Sheets Drwg.	Figs.Drw(	p. Print Fig.			
		Primary Examiner						
TERMINAL		PREPARED FOR ISSUE	Examiner					
	DISCLAMER	WARNING: The information disclosed herein may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368, Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only.						
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(Attached in pocket on right inside flap)